



# AK5434D

Dual channel 14bit 30MHz A/D Converter with differential input

## Features

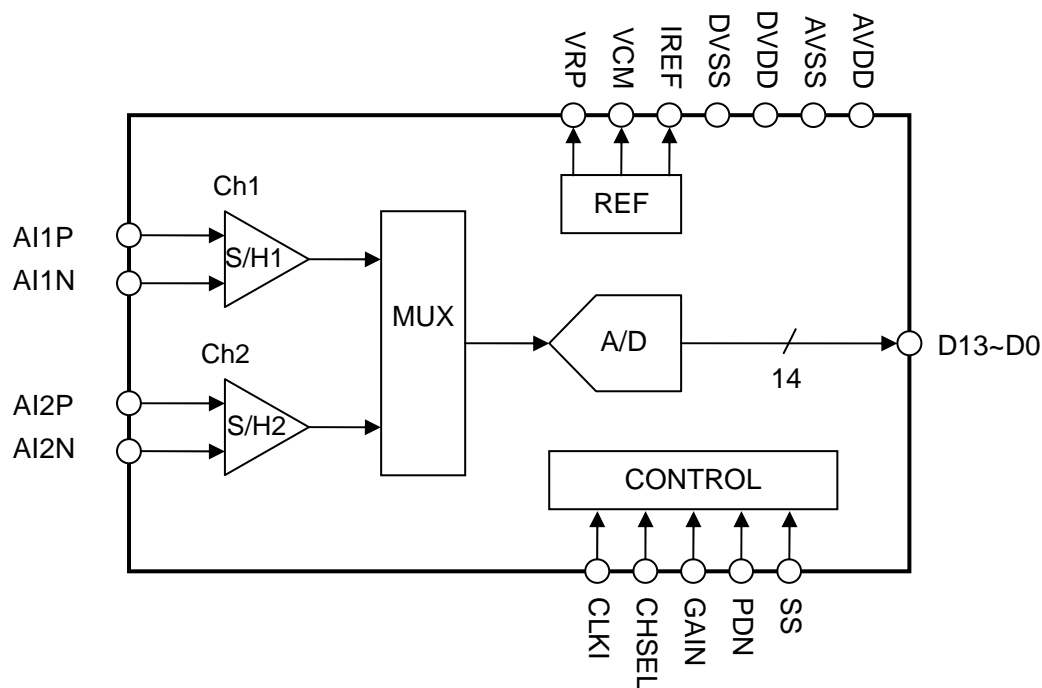
【Power Supply】 3.0V~3.45V Single-Supply

【Operation Temperature】  $-40^{\circ}\text{C}\sim+105^{\circ}\text{C}$

【Package】 30pinVSOP (Pin pitch 0.65mm)

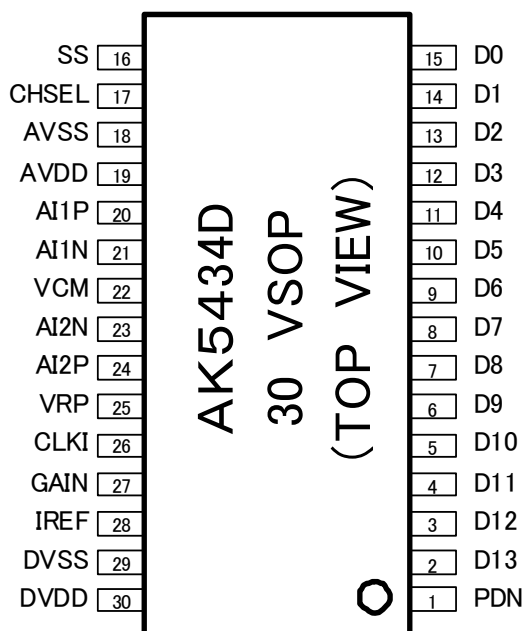
Input range : 4V (Differential input @ Gain 0dB)  
 Input signal bandwidth : DC ~ 400MHz (typ.)  
 S/H Gain : 0dB/6dB/12dB  
 ADC : 14bit, 30MHz  
 S/(N+D) : 69dB (typ.)  
 (30MHz operation, input signal frequency 14.9MHz@1ch)  
 Outputs : 14bit parallel data with straight binary  
 Power consumption : 172mW @typ. (power consumption @Power Down mode: under 1mW)

## Circuit Block Diagram



Clock	Function
S/H1, S/H2	Sample/Hold AMP
MUX	Switch that selects input signal to A/D from S/H1 and S/H2
A/D	14bit 30MSPS A/D Converter
REF	Reference voltage generator
CONTROL	Operation control circuit

**Pin Allocation**



<b>Pin Description</b>
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No.	Name	I/O	@Power down	Description
1	PDN	I	–	Power down (H: Normal Operation, L: Power down)
2	D13	O	High-Z	ADC output data MSB Straight binary code
3	D12	O	High-Z	ADC output data
4	D11	O	High-Z	ADC output data
5	D10	O	High-Z	ADC output data
6	D9	O	High-Z	ADC output data
7	D8	O	High-Z	ADC output data
8	D7	O	High-Z	ADC output data
9	D6	O	High-Z	ADC output data
10	D5	O	High-Z	ADC output data
11	D4	O	High-Z	ADC output data
12	D3	O	High-Z	ADC output data
13	D2	O	High-Z	ADC output data
14	D1	O	High-Z	ADC output data
15	D0	O	High-Z	ADC output data LSB
16	SS	I	–	Sampling timing setting L: Sampling timing is determined by applying Logic to CHSEL-pin. H: The sampling timing is the timing of CHSEL=L. Ch1 and Ch2 are sampled simultaneously.
17	CHSEL	I	–	Ch1/Ch2 select (L:Ch1, H:Ch2)
18	AVSS	PWR	–	Analog Ground
19	AVDD	PWR	–	Analog supply (3.0V~3.45V)
20	AI1P	I	–	Ch1 differential input P side
21	AI1N	I	–	Ch1 differential input N side
22	VCM	O	High-Z	Common-mode voltage output Connect 1 $\mu$ F between AVSS and this pin.
23	AI2N	I	–	Ch2 differential input N side
24	AI2P	I	–	Ch2 differential input P side
25	VRP	O	L	ADC Reference-voltage output. Connect 1 $\mu$ F between AVSS and this pin.
26	CLKI	I	–	ADC clock input
27	GAIN	I	–	S/H gain setting (L:0dB, M:12dB, H:6dB)
28	IREF	O	High-Z	bias current output Connect 8.2k $\Omega$ between AVSS and this pin.
29	DVSS	PWR	–	Digital Ground
30	DVDD	PWR	–	Digital Power Supply (3.0V~3.45V)

(NOTE) I/O I: INPUT, O: OUTPUT, PWR: POWER/GROUND

<b>Absolute Maximum Ratings</b>
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AVSS, DVSS=0V, All voltages are with respect to ground

Parameter	Symbol	Min.	Max.	Unit	Note
Power Supplies					
Analog	AVDD	-0.3	4.0	V	
Digital	DVDD	-0.3	4.0	V	
Input Current	IIN	-10	10	mA	Except AVDD, AVSS, DVDD, DVSS pins
Analog Input Voltage Range (Note 1)	VINA	-0.3	AVDD+0.3	V	
Digital Input Voltage Range (Note 2)	VIND	-0.3	DVDD+0.3	V	
Operating Temperature	Ta	-40	105	°C	
Storage Temperature	Tstg	-65	150	°C	

(Note 1) AI1P, AI1N, AI2P, AI2N, GAIN, CLKI

(Note 2) CHSEL, SS, PDN

All power supply ground pins (AVSS, DVSS) should be at the same potential.

**WARNING:** Operation at or beyond these limits may result in permanent damage to the device.

Normal Operating Specifications are not guaranteed at these extremes.

<b>Operating Condition</b>
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Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Supply Voltage						
Analog (Core)	AVDD	3.0	3.3	3.45	V	
Digital (Core, IO)	DVDD	3.0	3.3	3.45	V	

Power supply voltages are values where each ground pin (AVSS=DVSS) is at 0V (Voltage reference)

All power supply ground pins (AVSS, DVSS) should be at the same potential.

<b>Electrical Characteristics</b>
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■ Analog Specifications

(AVDD=DVDD=3.3V, S/H gain=0dB, Ta=25°C, CLKI=30MHz, fin=14.9MHz, Signal Level=3.4Vpp-diff)

Parameter	Symbol	Condition	min	Typ	Max	Units
DC Characteristics						
Resolution	RES				14	Bits
Integral Non-Linearity	INL			±2.8	±10.5	LSB
Differential Non-Linearity	DNL			±0.8	±4.0	LSB
Offset	EOC	AIxP=AIxN=VCM (x=1,2)			±100	LSB
Gain Error	GERR	Gain setting 0dB	-10	0	+10	%FS
Gain		Gain setting 6dB	5.5	6	6.5	dB
		Gain setting 12dB	11.5	12	12.5	dB
Input Range	AINFS	Gain setting 0dB	3.6	4.0	4.4	Vpp-diff
Common Voltage	VCM		1.26	1.4	1.54	V
ADC Reference Voltage	VRP		1.8	2.0	2.2	V
AC Characteristics						
S/N	SNR		68	73		dB
S/(N+D)	SND		64	69		dB
S/(N+D) (Note 1)	SND2	fin=1MHz	66	71		dB
SFDR	SFDR			70		dB
Total Harmonic Distortion	THD		64	70		dBc
Input Resistance (Note 1)	RIN	(Note 4)		60		kΩ
Input Capacitance (Note 1)	CIN			5	8	pF
Input Signal bandwidth (Note 1)	BW	-3dB Level		400		MHz
CMRR	CMR	fin=1MHz, common swing -26dB	50	56		dB
Crosstalk	CTK	fin=7.45MHz		-80	-70	dB
Current Consumption	IA	Analog fin=1MHz		46	68	mA
	ID	Digital(Note 2) fin=1MHz		6	9	mA
	IPD				0.3	mA
Current Consumption in power down	IAS	Analog			0.1	mA
	IDS	Digital (Note 3)			0.1	mA

(Note 1) Design Value

(Note 2) CL=10pF are connected to D0~D13 pins.

(Note 3) Power down PDN=Low, CLKI=Low fix, Current consumption without no input signal.

(Note 4) Equivalent resistance that from VCM operation middle point to differential input pins AI1P/N, AI2P/N. It is in inverse proportion to sampling frequency.

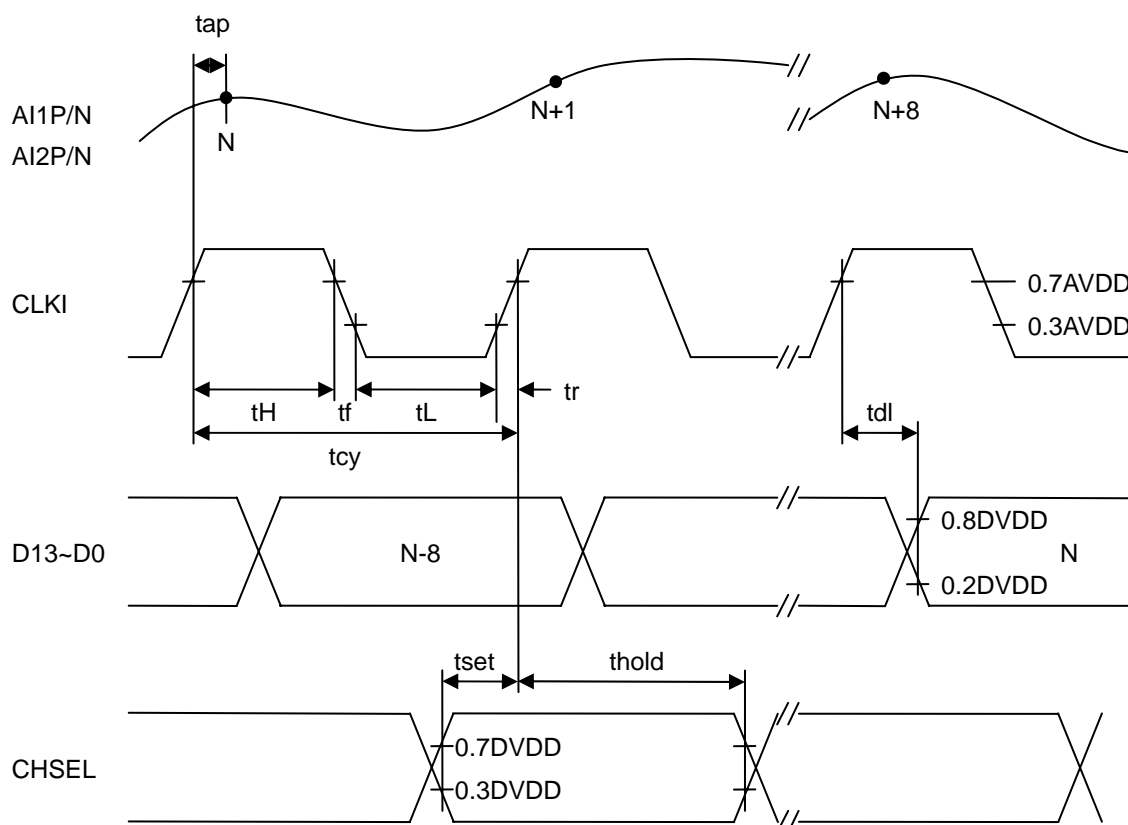
■ Switching Characteristics

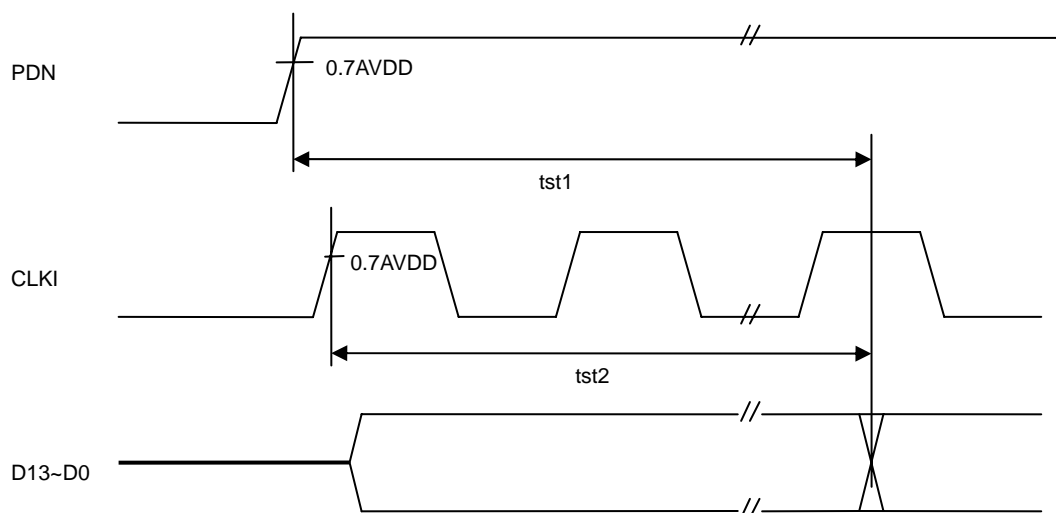
(AVDD=DVDD=3.0~3.45V, Ta=-40~105°C, CL=10pF)

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Conversion rate	fs		15		30	MHz
Clock cycle	tcy		33.3		66.7	ns
Clock rise time Note 1	tr	0.3AVDD to 0.7AVDD		2	15	ns
Clock fall time Note 1	tf	0.7AVDD to 0.3AVDD		2	15	ns
Clock High width	tH		15			ns
Clock Low width	tL		15			ns
Clock duty	tduty		40	50	60	%
Pipeline delay Note 2	tpd			8		CLKI
Aperture delay Note 2	tap			2	4	ns
AD output delay	tdl		0	6	20	ns
CHSEL setup	tset		10			ns
CHSEL hold	thold		10			ns
Start up time 1	tst1			2	5	ms
Start up time 2	tst2			2	5	ms

Note 1) Clock high width and Low width must be fulfilled.

Note 2) Design Value





■ Digital DC Characteristics

( $AVDD=DVDD=3.0\sim 3.6V$ ,  $T_a=-40\sim 105^{\circ}C$ )

Parameter	Symbol	Pin	Min.	Max.	Unit	Remark
High level input threshold 1	VIH1	Note 1	$0.7 \times DVDD$		V	
Low level input threshold 1	VIL1	Note 1		$0.3 \times DVDD$	V	
High level input threshold 2	VIH2	Note 2	$0.7 \times AVDD$		V	
Low level input threshold 2	VIL2	Note 2		$0.3 \times AVDD$	V	
High level input threshold 3	VIH3	GAIN	$0.8 \times AVDD$		V	
Middle level input threshold 3	VIM3	GAIN	$0.3 \times AVDD$	$0.7 \times AVDD$	V	
Low level input threshold 3	VIL3	GAIN		$0.2 \times AVDD$	V	
High level output voltage	VOH	Note 3, Note 4	$0.8 \times DVDD$		V	
Low level output voltage	VOL	Note 3, Note 5		$0.2 \times DVDD$	V	
Input leakage current	ILKG	Note 1, Note2, GAIN		$\pm 10$	$\mu A$	
High-Z leakage current	IOZ	Note 3		$\pm 10$	$\mu A$	

Note 1) CHSEL, SS, PDN,

Note 2) CLKI

Note 3) D13~D0

Note 4)  $IOH = -1mA$

Note 5)  $IOL = 1mA$

<b>Functional Description</b>
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## Power down function

Power Down mode can be activated by applying a logic Level “0” to the PDN-pin. All the data output pins [D13: D0] become Low state.at Power Down mode.

PDN	Condition
L	Power down
H	Normal opration

## S/H AMP gain select

The gain of the S/H amplifier can be selected by the input level of GAIN-pin.

GAIN	Gain	Input full scale
AVSS	0dB	4V <sub>pp</sub> -diff
AVDD	6dB	2V <sub>pp</sub> -diff
VCM	12dB	1V <sub>pp</sub> -diff

## Sampling timing setting

The sampling timing of two channels can be set with SS-pin.

SS	Sampling timing
L	S/H1 or S/H2 samples the signal according to CHSEL.
H	At CHSEL=L, S/H1 and S/H2 sample the signal at the same time.

## Sampling channel select

The samples timing can be selected with CHSEL-pin.

## Separate sampling (@SS=Low)

CHSEL	Sampling channel
L	S/H1
H	S/H2

## Simultaneous sampling (@SS=High)

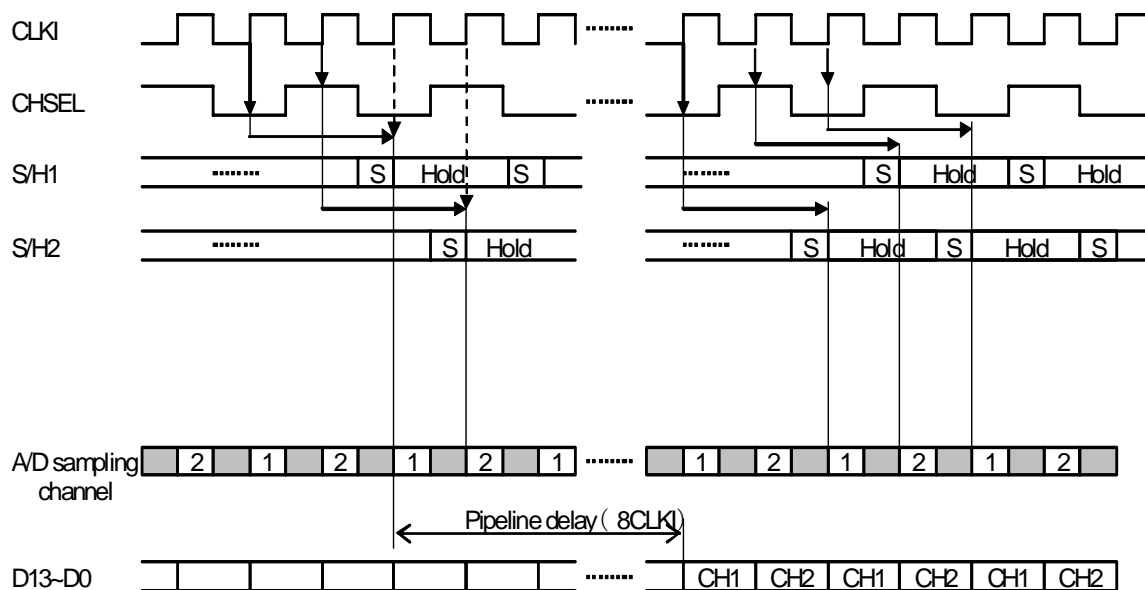
CHSEL	Sampling channel
L	S/H1 & S/H2
H	Not sampled

Only at CHSEL=Low, sampling is done at the same timing (SS=High).

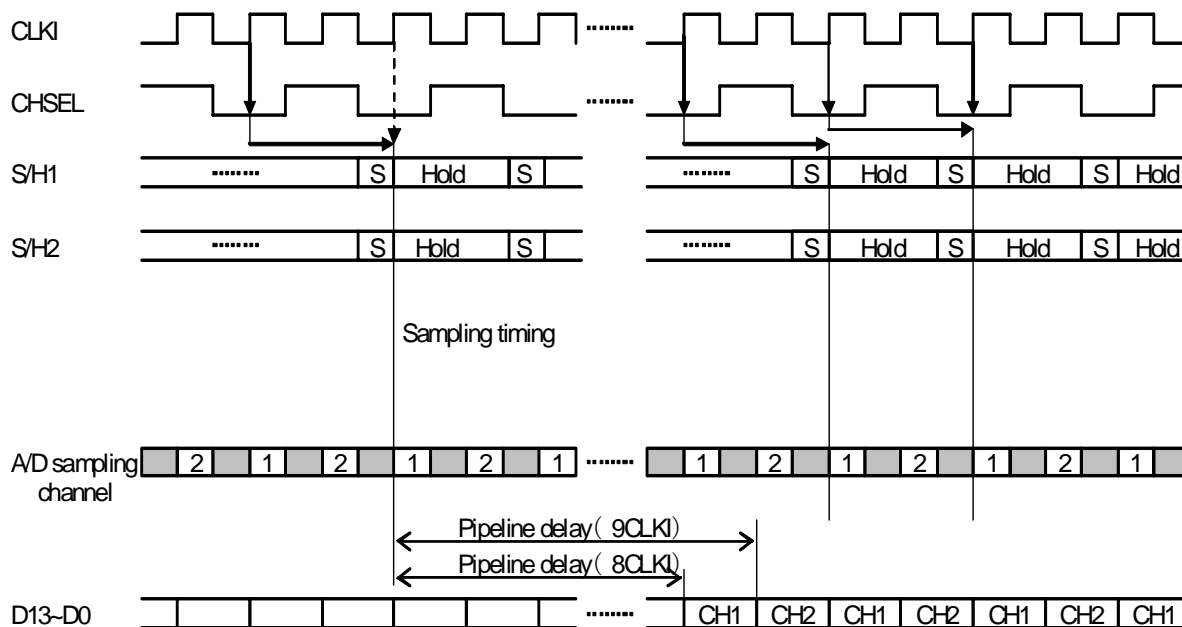


■ Operation timing

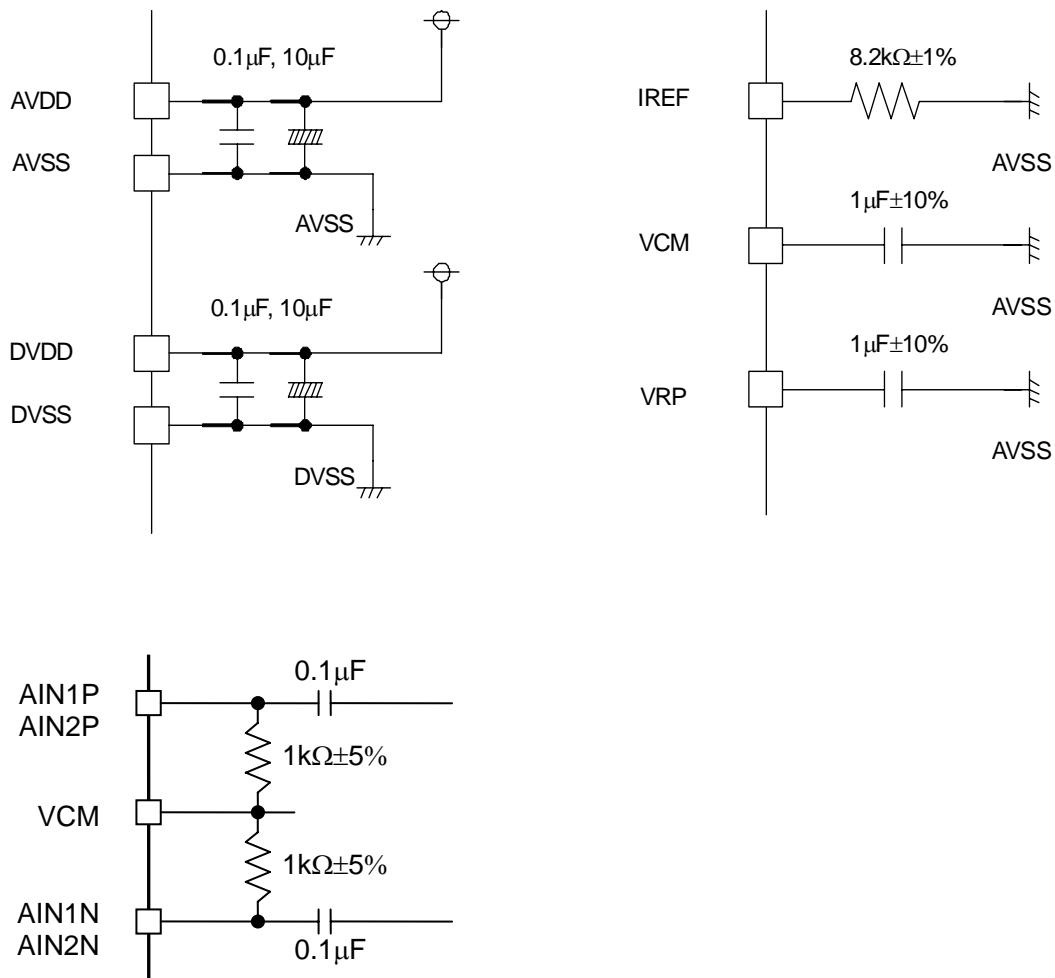
At SS="L"



At SS="H"

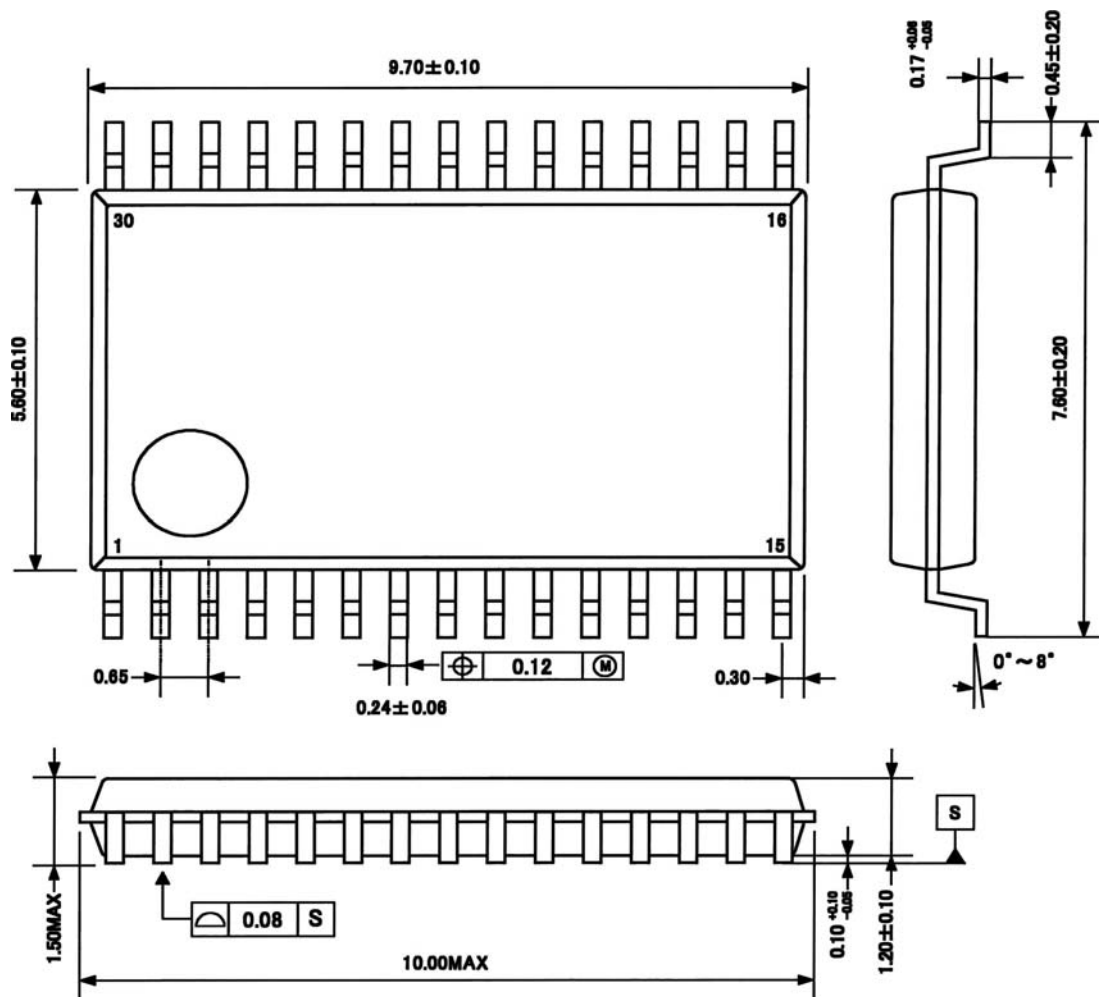


**External Circuit Examples**



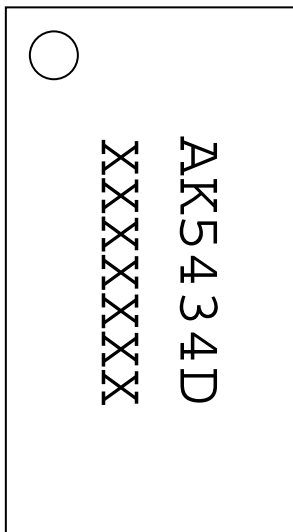
Note) Resistors must be metal-film type.

Packages



30-VSOP-0.65

**Marking**



Marketing Code: AK5434D

Date Code: XXXXXXXX

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